

XL6001

Features

- Wide 3.6V to 24V Input Voltage Rang
- 0.22V Constant Current Sense Voltage
- Directly drive 3~8 Series 1W LED
- Fixed 400KHz Switching Frequency
- Max. 2A Switching Current Capability
- Up to 92% efficiency
- Excellent line and load regulation
- EN PIN TTL shutdown capability
- Internal Optimize Power MOSFET
- Built in LED Open Protection
- Built in Soft-Start Function
- Built in Frequency Compensation
- Built in Thermal Shutdown Function
- Built in Current Limit Function
- Available in SOP8 package

Applications

- LED Lighting
- Boost constant current driver
- Monitor LED Backlighting
- 7' to 15' LCD Panels

General Description

The XL6001 regulator is fixed frequency PWM Boost (step-up) LED constant current driver, capable of driving Series 1W LED units with excellent line and load regulation. The regulator is simple to use because it includes internal frequency compensation and a fixed-frequency oscillator so that it requires a minimum number of external components to work.

The XL6001 could directly drive 5~8 Series 1W LED units at VIN>12V.

The PWM control circuit is able to adjust the duty ratio linearly from 0 to 90%. An enable function, an over current protection function is built inside. An internal compensation block is built in to minimize external component count.



Figure 1. Package Type of XL6001



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Pin Configurations

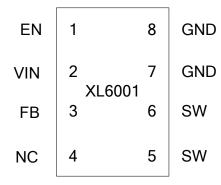


Figure 2. Pin Configuration of XL6001 (Top View)

Table 1 Pin Description

Pin Number	Pin Name	Description
1	EN	Enable Pin. Drive EN pin low to turn off the device, drive it high
1		to turn it on. Floating is default high.
		Supply Voltage Input Pin. XL6001 operates from a 3.6V to 24V
2	VIN	DC voltage. Bypass Vin to GND with a suitably large capacitor
		to eliminate noise on the input.
3	FB	Feedback Pin (FB). The feedback threshold voltage is 0.22V.
4	NC	No Connected.
5,6	SW	Power Switch Output Pin (SW). Output is the switch node that
5,0		supplies power to the output.
7,8	GND	Ground Pin.



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Function Block

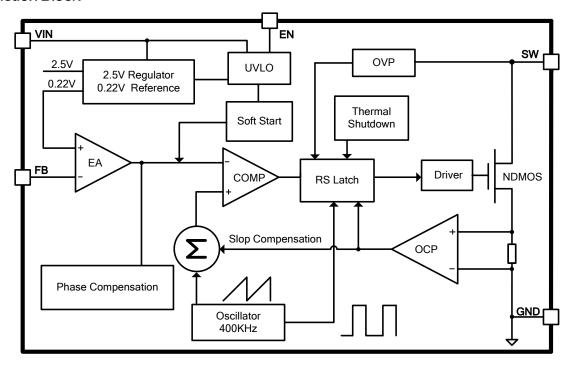


Figure 3. Function Block Diagram of XL6001

Typical Application Circuit

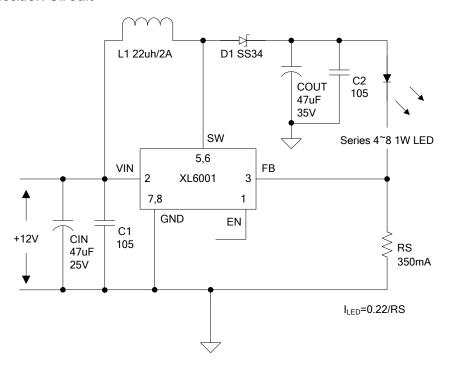


Figure 4. XL6001 Typical Application Circuit



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Ordering Information

Order Information	Marking ID	Package Type	Packing Type Supplied As
XL6001E1	XL6001E1	SOP8	2500/4000 Units on Tape & Reel

XLSEMI Pb-free products, as designated with "E1" suffix in the par number, are RoHS compliant.

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit	
Input Voltage	Vin	-0.3 to 26	V	
Feedback Pin Voltage	$V_{\sf FB}$	−0.3 to Vin	V	
EN Pin Voltage	V _{EN}	−0.3 to Vin	V	
Output Switch Pin Voltage	V _{SW}	-0.3 to 32	V	
Power Dissipation	P₀	Internally limited	mW	
Thermal Resistance (SOP8)	Б	100	°C/W	
(Junction to Ambient, No Heatsink, Free Air)	R _{JA}	100	C/VV	
Operating Junction Temperature	TJ	-40 to 125	°C	
Storage Temperature	Тѕтӄ	-65 to 150	°C	
Lead Temperature (Soldering, 10 sec)	T _{LEAD}	260	°C	
ESD (HBM)		>2000	V	

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.



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XL6001 Electrical Characteristics

 $T_a = 25$ °C;unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
System parameters test circuit figure4						
VFB	Feedback Voltage	Vin = 5V to 12V, Vout=24V lload=100mA	209	220	231	mV
η	Efficiency	Vin=12V ,Vout= 6*1W LED lout=0.3A	_	92	-	%

Electrical Characteristics (DC Parameters)

Vin = 12V, GND=0V, Vin & GND parallel connect a 47uf/25V capacitor; lout=50mA, T_a = 25°C; the others floating unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Input operation voltage	Vin		3.6		24	V
Shutdown Supply Current	ls	V _{EN} =0V		70	100	uA
Quiescent Supply Current	Iq	V _{EN} =2V, V _{FB} =Vin		2.5	5	mA
Oscillator Frequency	Fosc		320	400	480	Khz
Switch Current Limit	l _L	V _{FB} =0V		2		А
Output Power NMOS	Rdson	Vin=12V, I _{sw} =2A		110	120	mohm
EN Pin Threshold	V _{EN}	High (Regulator ON) Low (Regulator OFF)		1.4 0.8		V
EN Pin Input Leakage	lн	V _{EN} =2V (ON)		3	10	uA
Current	lL	V _{EN} =0V (OFF)		3	10	uA
Max. Duty Cycle	D _{мах}	V _{FB} =0V	_	90		%



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Typical System Application for VIN=5V to driver 2~3 x 1W series LED units

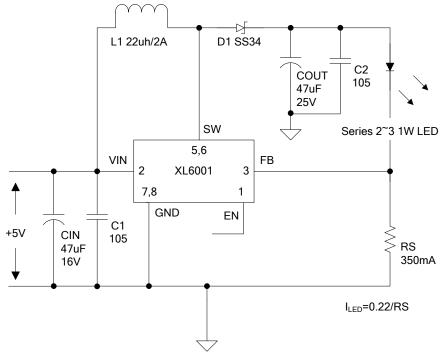


Figure 5. XL6001 System Parameters Test Circuit (2~3 x 1W LED)

Typical System Application for VIN=12V to driver 4~8 x 1W series LED units

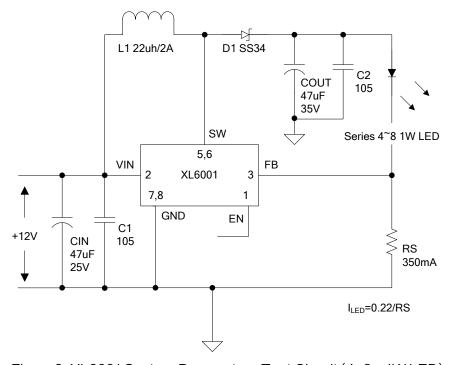


Figure 6. XL 6001 System Parameters Test Circuit (4~8 x 1W LED)



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Typical System Application for VIN=12V to driver 4~8 x 1W series LED units With PWM Dimming

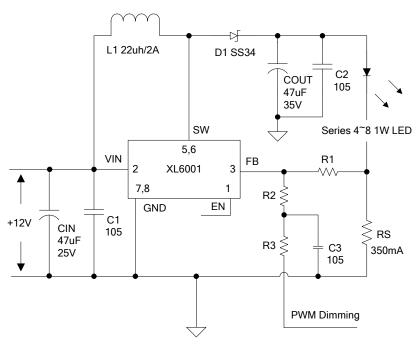


Figure 7. XL 6001 System Parameters Test Circuit (4~8 x 1W LED with PWM Dimming)

Typical System Application for SEPIC Buck-Boost LED Driver

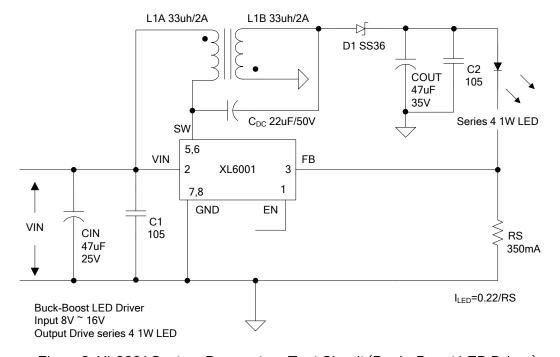


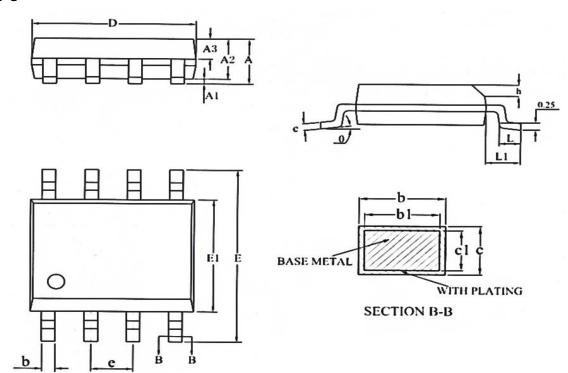
Figure 8. XL6001 System Parameters Test Circuit (Buck-Boost LED Driver)



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Package Information

SOP8



Symbol	Dimensions In Millimeters			Dimensions In Inches			
	Min.	Nom.	Max.	Min.	Nom.	Max.	
А	1.35	1.55	1.75	0.053	0.061	0.069	
A1	0.05	_	0.25	0.002	_	0.010	
A2	1.25	1.40	1.65	0.049	0.055	0.065	
А3	0.50	0.60	0.70	0.019	0.024	0.028	
b	0.30	_	0.51	0.012	_	0.020	
b1	0.29	0.41	0.48	0.011	0.016	0.018	
С	0.17	_	0.25	0.007	_	0.010	
c1	0.17	0.20	0.23	0.007	0.008	0.009	
D	4.70	4.90	5.10	0.185	0.193	0.200	
E	5.80	6.00	6.20	0.228	0.236	0.244	
E1	3.80	3.90	4.00	0.150	0.154	0.157	
е	1.14	1.27	1.40	0.045	0.050	0.055	
h	0.25	_	0.50	0.010	_	0.020	
L	0.45	_	0.80	0.017	_	0.031	
L1	0.82	1.03	1.23	0.032	0.040	0.048	
θ	0	-	8°	0	_	8°	



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